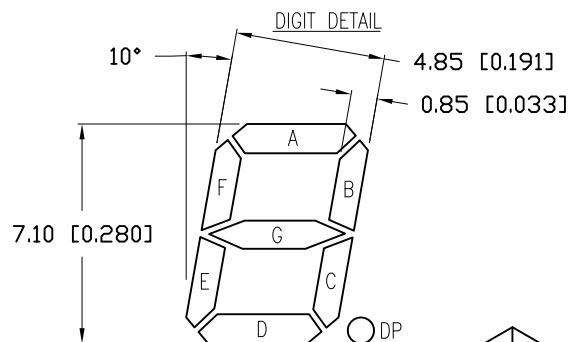
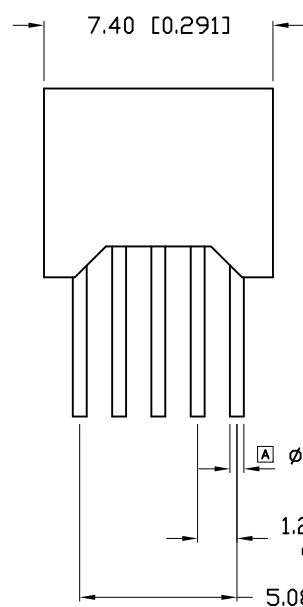
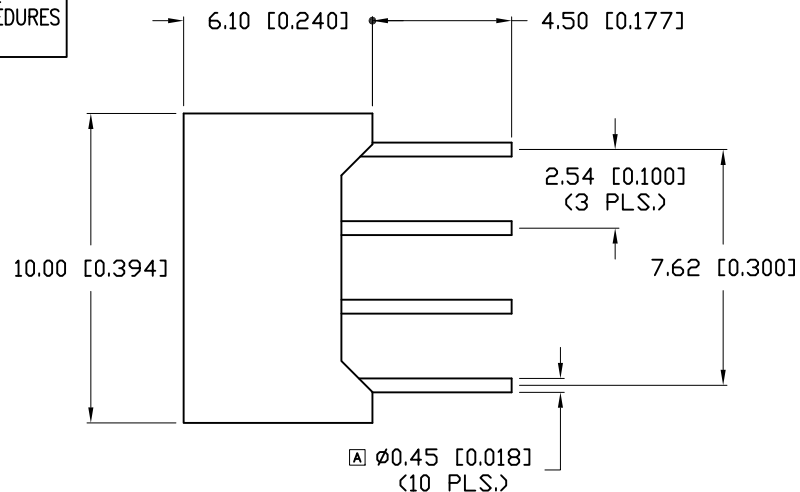
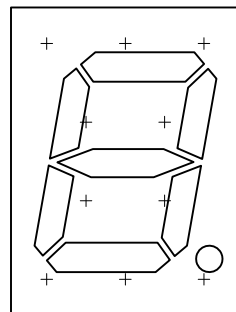
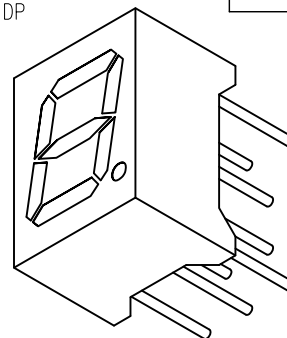
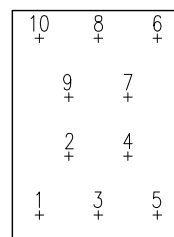


CAUTION: STATIC SENSITIVE DEVICE
FOLLOW PROPER E.S.D. HANDLING PROCEDURES
WHEN WORKING WITH THIS PART.



PIN LAYOUT TOP VIEW



PART NUMBER	LDS-C2802RI-UPG	REV.	B
DATE	E.C.N. NUMBER AND REVISION COMMENTS		
12.10.09	E.C.N. #11601.		
03.06.13	E.C.N. #10BRDR. & REDRAWN.		
		REV.	A
			B

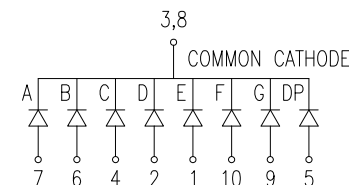
A

ELECTRO-OPTICAL CHARACTERISTICS $T_A=25^\circ\text{C}$ $I_f=10\text{mA}$

PARAMETER	MIN	TYP	MAX	UNITS	TEST COND
PEAK WAVELENGTH		525		nm	
FORWARD VOLTAGE		3.5	4.0	V_f	
REVERSE VOLTAGE	5.0			V_r	$I_r=100\mu\text{A}$
AXIAL INTENSITY		7000		μcd	$I_f=10\text{mA}$
EMITTED COLOR:	GREEN				
FACE COLOR:	GRAY				
SEGMENT COLOR:	MILKY WHITE DIFFUSED				

LIMITS OF SAFE OPERATION AT 25°C PER CHIP

PARAMETER	MAX	UNITS
PEAK FORWARD CURRENT*	150	mA
STEADY CURRENT	25	mA
POWER DISSIPATION	120	mW
DERATE FROM 25°C	-1.2	mW/ $^\circ\text{C}$
OPERATING, STORAGE TEMP.	-30 TO +85	$^\circ\text{C}$
SOLDERING TEMP.	+260	$^\circ\text{C}$
2.0mm FROM BODY	3 SEC. MAX	

* $t < 10\mu\text{s}$ 

*UNLESS OTHERWISE SPECIFIED TOLERANCES PER DECIMAL PRECISION ARE: $X=\pm 1$ (± 0.039), $X.X=\pm 0.5$ (± 0.020), $X.XX=\pm 0.25$ (± 0.010), $X.XXX=\pm 0.127$ (± 0.005). LEAD SIZE= ± 0.05 (± 0.002), LEAD LENGTH= ± 0.75 (± 0.030). MIN= $\frac{+0.00}{-0.00}$ DECIMAL PRECISION MAX= $\frac{+0.00}{-0.00}$ DECIMAL PRECISION

UNCONTROLLED DOCUMENT